

# 2026 HSPA CONFERENCE SCHOLARSHIP APPLICATION

The HSPA Foundation, HSPA's philanthropic arm, was created to provide valuable education and support to Sterile Processing (SP) professionals through educational initiatives, research, scholarships, professional development grants, and awards.

The HSPA Foundation will provide 12 scholarships for the 2026 HSPA Conference at the Baltimore Convention Center in Baltimore, Maryland. (April 25–28, 2026). The Foundation will provide 10 scholarships, Owens & Minor will provide one scholarship and Healthmark will provide one scholarship in honor of Anne Cofiell. Anne was a loyal supporter of the SP profession who advocated tirelessly about the critical importance of safe, high-quality medical device processing—beginning with effective, thorough and consistent cleaning. She was an active member of HSPA and served on AAMI working groups throughout her long career.

The scholarships will cover the conference registration fee and hotel accommodations for up to four nights. *Note: transportation and other incurred expenses are not included.* 

Scholarship & Submission Requirements:

- Applicant must be currently employed in a Sterile Processing/Central Service or material management department
- Applicant must provide demonstrated commitment to continuing education and best practices
- Applicant must be a certified technician (CRCST, CER, CSPDT or CFER)
- Applicant must submit the scholarship application along with a letter of recommendation from a current supervisor/manager **on company letterhead**
- Application must be submitted by November 7, 2025
  (Please note: any applications that do not meet the above criteria will not be accepted).

## SECTION 1 — APPLICANT INFORMATION

Date:
First and Last Name of Applicant:
Title/Job Position:
Place of Employment/Company Name:
Phone:
Email:
□ CRCST □ CER □ CSPDT □ CFER
HSPA ID# (if applicable):
Have you attended the HSPA Conference in the past?:

myHSPA.org



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## SECTION 2 — ESSAY

1) Why do you want to attend the 2026 HSPA Conference? (min. 100 words)
SECTION 3 — SUBMISSION CHECKLIST

	Scho	larship	App	lication
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- \_\_\_\_ Letter of reference from a current supervisor/manager on company letterhead
- \_\_\_\_ Essay Minimum of 100 words

### Send to:

**Mail:** HSPA Foundation Scholarships 55 West Wacker Drive Suite 501 Chicago, IL 60601

**Fax:** 312.440.9474

Email: foundation@myhspa.org





